

GPU SuperServer SYS-210GP-DNR

2U 2-Node Multi-GPU System with Single Processor (Intel) and Up to 3 PCI-E GPUs per Node



Key Applications

High Performance Computing Al/Deep Learning Training Media/Video Streaming Industrial Automation, Retail Cloud Gaming

Key Features

- Single Socket P+ (LGA-4189) 3rd Gen Intel® Xeon® Scalable Processor;
- Intel® C621A Chipset;
- 2TB Registered ECC DDR4 3200MHz SDRAM in 8 DIMMs;
- 3 PCI-E Gen 4.0 x16 FHFL DW;
- 2 front Hot-swap 2.5" U.2 NVMe Gen4 drive bays; 2 M.2 NVMe and SATA for boot drive only;
- 2600W Redundant (1+1) Power Supplies Titanium Level (96%) (Full redundancy based on configuration and application load);
- AST2500 BMC;

More details here



Form Factor	2U Rackmount Enclosure: 447 x 88 x 760mm (17.6" x 3.47" x 29.9") Package: 600 x 240 x 1100mm (23.62" x 9.44" x 43.3")	
Processor	3rd Gen Intel® Xeon® Scalable processors Single Socket LGA-4189 (Socket P+) supported TDP up to 270W;	
GPU	Supported GPU: NVIDIA A30, A40, A100 Intel® Data Center GPU Flex 140/170 GPU-GPU Interconnect: PCI-E	
System Memory	8 DIMM slots Up to 2TB ECC RDIMM, DDR4-3200MHz	
Drive Bays	2x 2.5" hot-swap NVMe Support drive bays; 2x 2.5" NVMe dedicated;	
Expansion Slots	Slot 1: PCI-E 4.0 x16 FHFL DW Slot 2: PCI-E 4.0 x16 FHFL DW Slot 3: PCI-E 4.0 x16 FHFL DW	
On-Board Devices	Chipset: Intel® C621A Network Connectivity: Via AIOM IPMI: Support for Intelligent Platform Management Interface v.2.0 IPMI 2.0 with virtual media over LAN and KVM-over-LAN support	
Input / Output	Video: 1 VGA port(s)	



(Front V	/iow – System)	(Rear View – System)
4x Hot-swap 8cm External Slot Description 0 • 0 2x Hot-swap PCLE Cent x		Node B Redundart 2000W VGA pot SpipU VGA pot Z Rear USB3.0 Dedicated IPMI LAN pot Dedicated IPMI LAN pot COM Pot Stat Name Stat States Image: Control of the states States Stat Name States Image: Control of the states Rection to the states
		*Full redundancy based on configuration and application load.
Cooling System	4 heavy duty fan(s)	
Power Supply	2600W Redundant Power Supplies with PMBus Dimension (W x H x L): 73.5 x 40 x 265 mm Output Type: 25 Pairs Gold Finger Connector	5
System BIOS	BIOS Type: AMI 32MB SPI Flash EEPROM	
Management	SuperDoctor® 5; Watch Dog; NMI; SUM; KVM v Redfish API; OOB Management Package (SFT-	with dedicated LAN; SPM; Intel® Node Manager; SSM; IPMI 2.0; -OOB-LIC)
PC Health Monitoring	CPU: Monitors for CPU Cores, Chipset Voltages 7 +1 Phase-switching voltage regulator FAN: Fans with tachometer monitoring Status monitor for speed control Pulse Width Modulated (PWM) fan connect Temperature: Monitoring for CPU and chassis e Thermal Control for fan connector	environment
Dimensions and Weight	Height: 3.47" (88 mm) Width: 17.6" (447 mm) Depth: 29.9" (760 mm) Gross Weight: 60 lbs (27.21 kg) Net Weight: 55 lbs (24.94 kg) Packaging: 9.44" (H) x 23.62" (W) x 43.3" (D) Available Color: Black Front & Silver Body	
Operating Environment	Operating Temperature: 10°C ~ 35°C (50°F ~ 98 Non-operating Temperature: -40°C to 60°C (-40 Operating Relative Humidity: 8% to 90% (non-co Non-operating Relative Humidity: 5% to 95% (no	0°F to 140°F) condensing)
Motherboard	Super X12SPG-NF	
Chassis	CSE-227GTS-R2K63P	